



US 20040056604A1

(19) **United States**(12) **Patent Application Publication**
Shih et al.(10) **Pub. No.: US 2004/0056604 A1**(43) **Pub. Date: Mar. 25, 2004**(54) **PIXEL STRUCTURE FOR AN ACTIVE MATRIX OLED****Publication Classification**(51) **Int. Cl.⁷** **G09G 3/10**(52) **U.S. Cl.** **315/169.2; 315/169.3**(76) **Inventors:** **Jun-Ren Shih**, Changhua (TW);
Shang-Li Chen, Hsinchu (TW);
Chien-Ru Chen, Pingtung (TW)

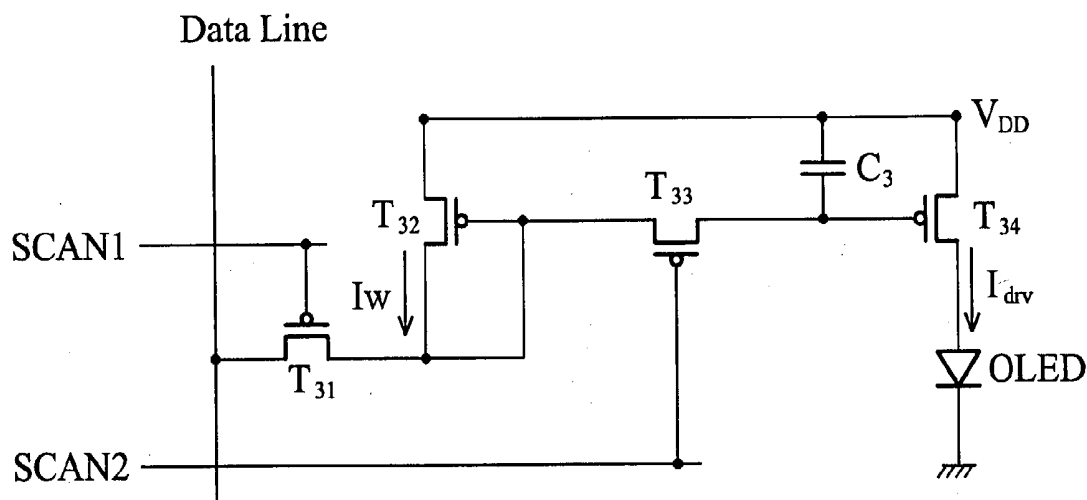
Correspondence Address:

BIRCH STEWART KOLASCH & BIRCH
PO BOX 747
FALLS CHURCH, VA 22040-0747 (US)(21) **Appl. No.:** **10/330,247**(22) **Filed:** **Dec. 30, 2002**(30) **Foreign Application Priority Data**

Sep. 19, 2002 (TW)..... 91121426

(57) **ABSTRACT**

A pixel structure for an active matrix OLED. A first switching transistor has a control terminal coupled to a first scan line, and a first terminal coupled to a data line. A first P-type transistor has a drain and a gate coupled to each other, and a source coupled to a voltage source. The drain is also coupled to a second terminal of the first switching transistor. A second P-type transistor has a source coupled to the voltage source, and a second switching transistor has two terminals coupled between gates of the first and second P-type transistors, and a control terminal coupled to a second scan line. A storage capacitor is coupled between the voltage source and the gate of the second P-type transistor. An OLED has an anode coupled to the drain of the second P-type transistor and a cathode coupled to ground.



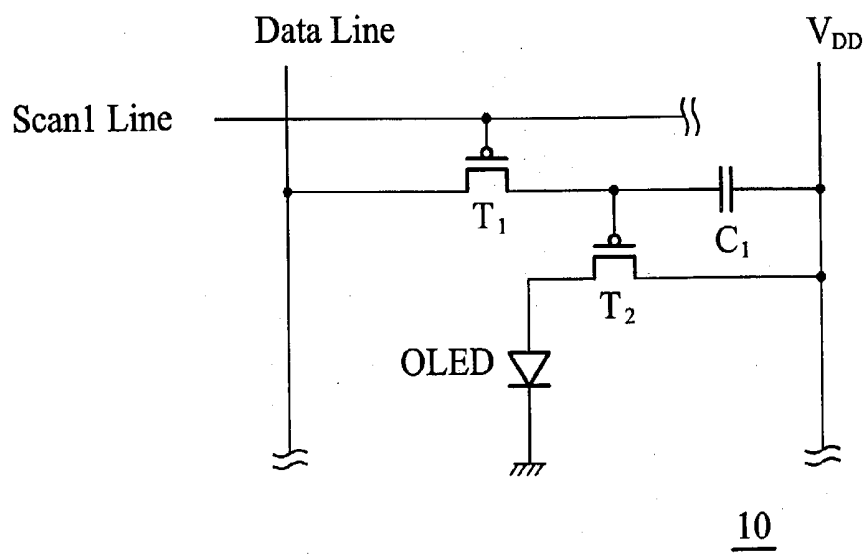


FIG. 1 (PRIOR ART)

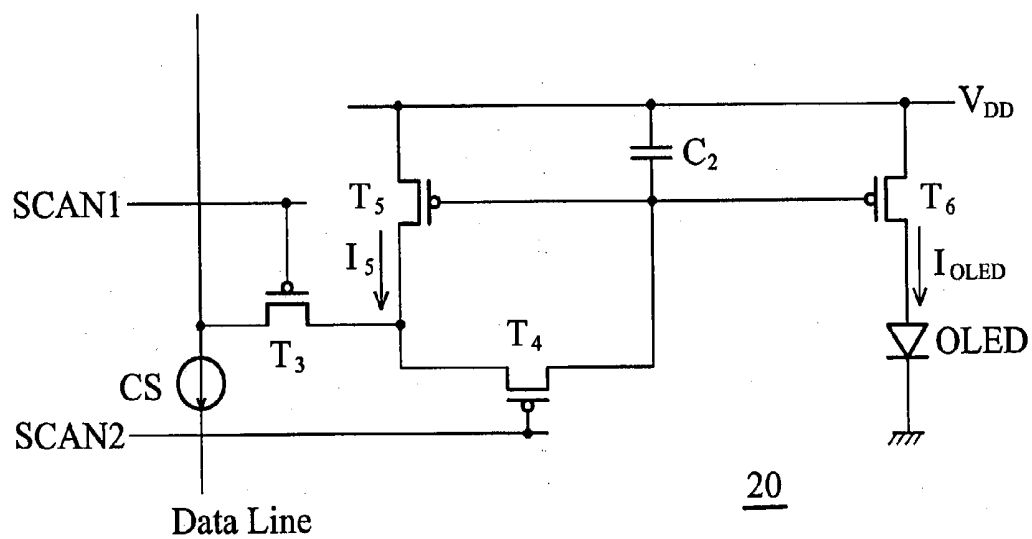


FIG. 2 (PRIOR ART)

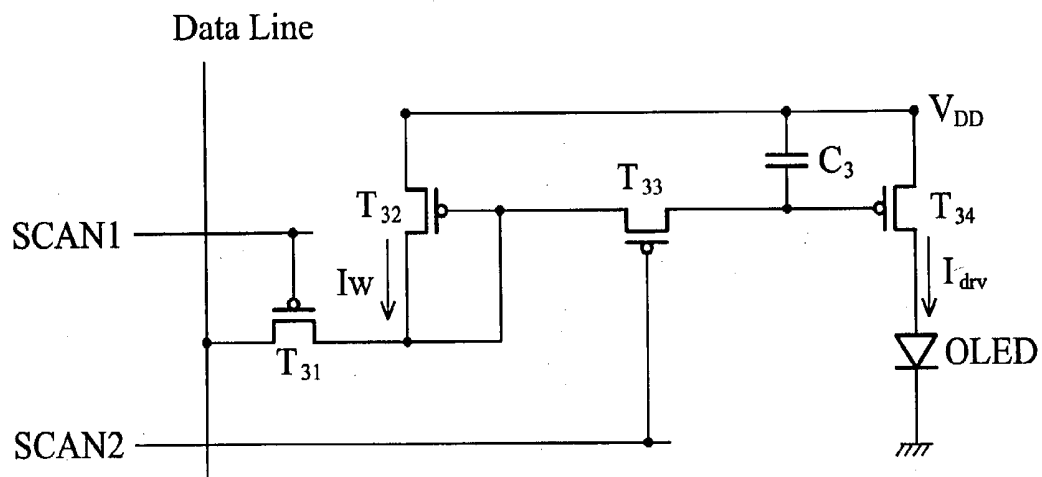


FIG. 3

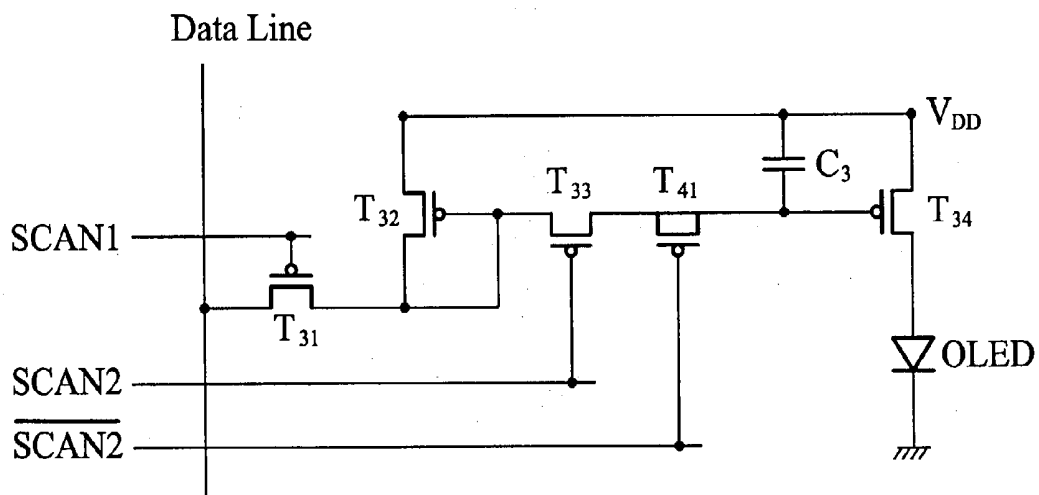


FIG. 4

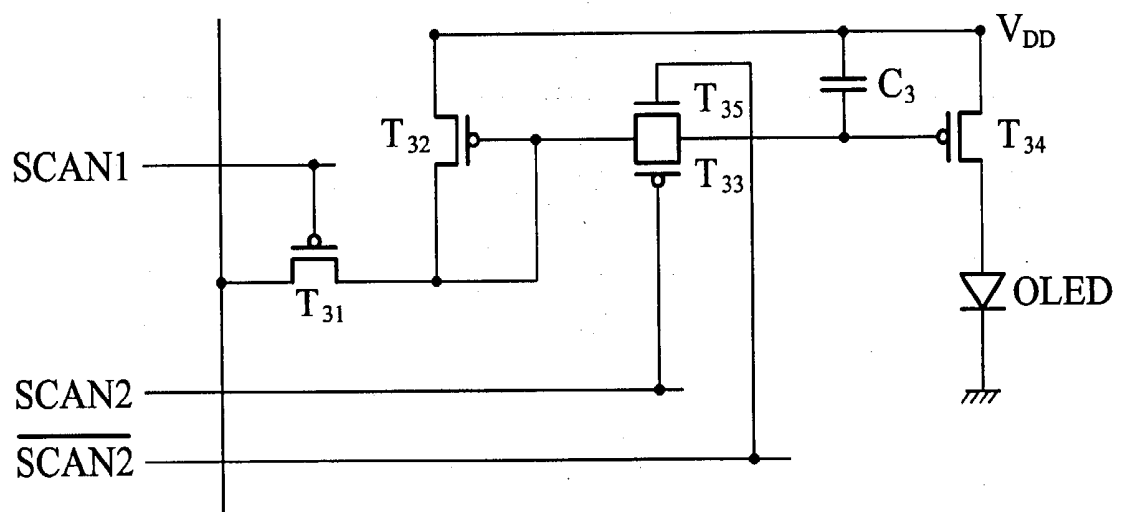


FIG. 5

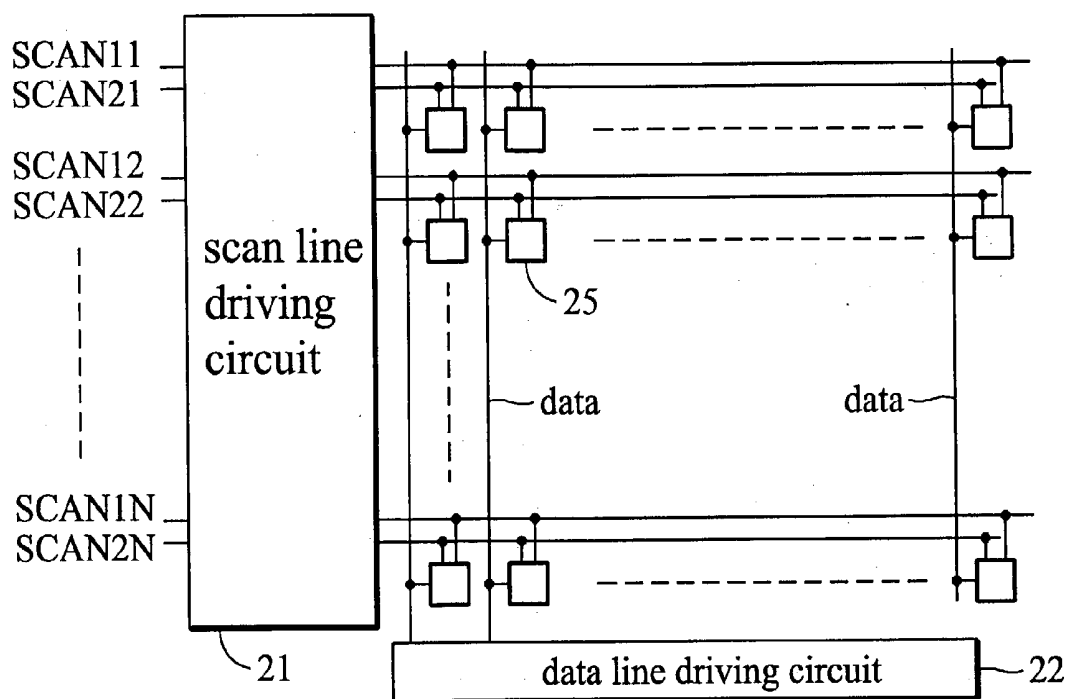


FIG. 6a

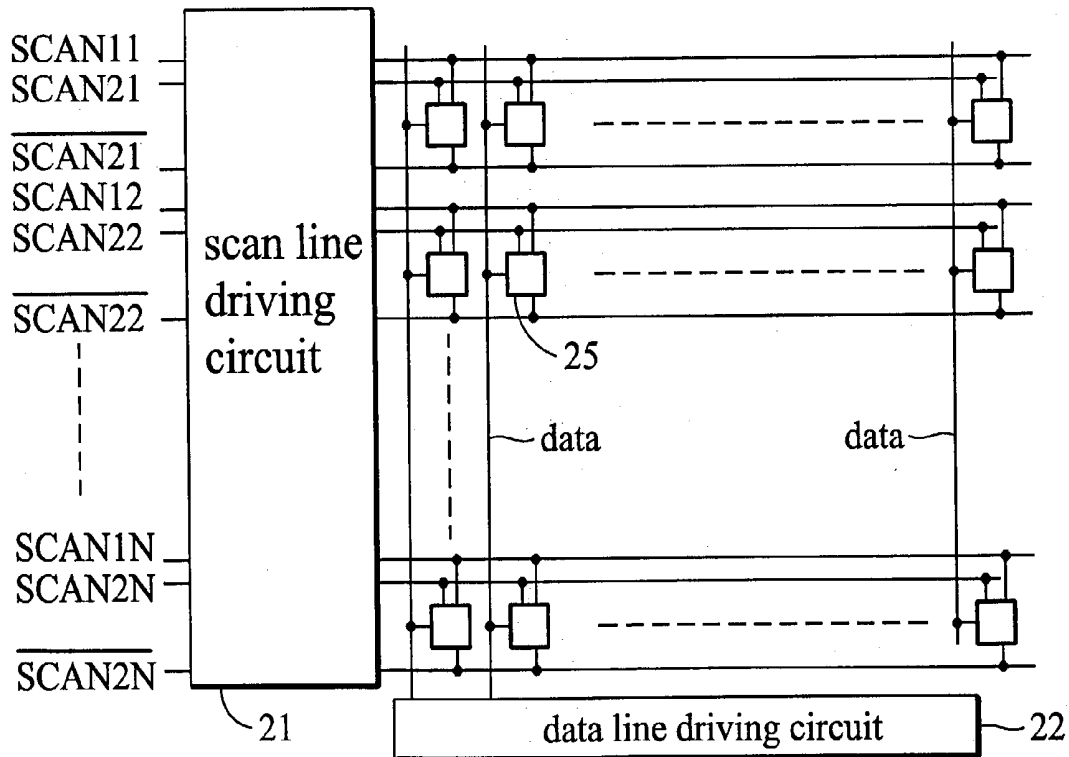


FIG. 6b

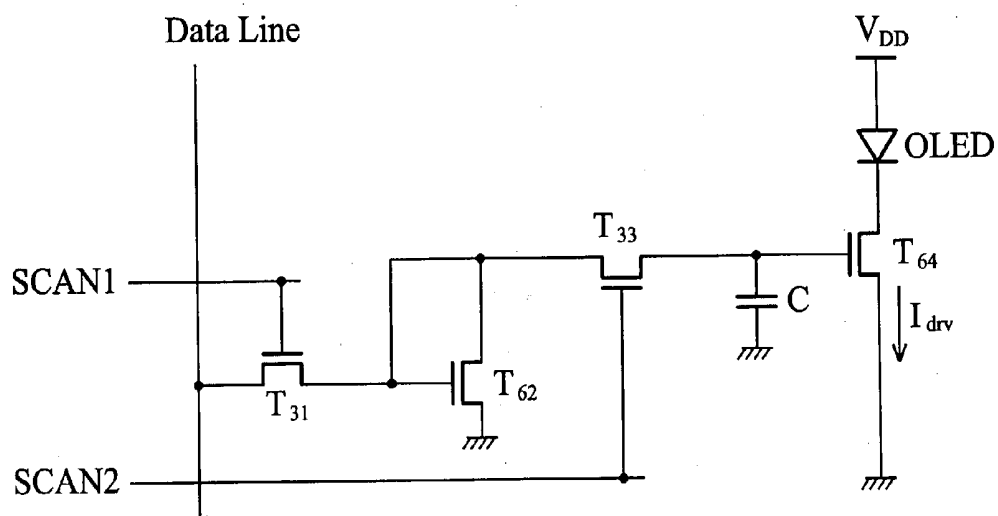


FIG. 7

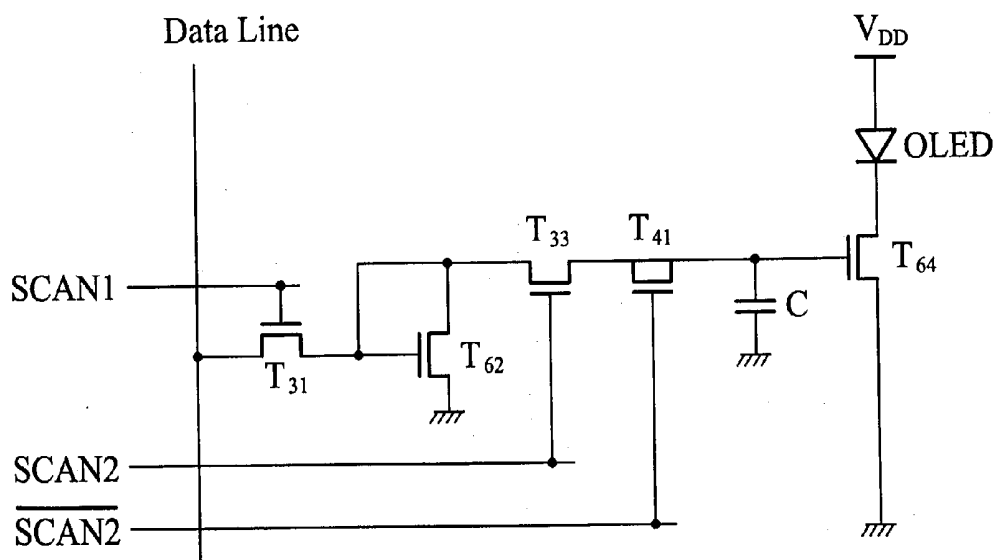


FIG. 8

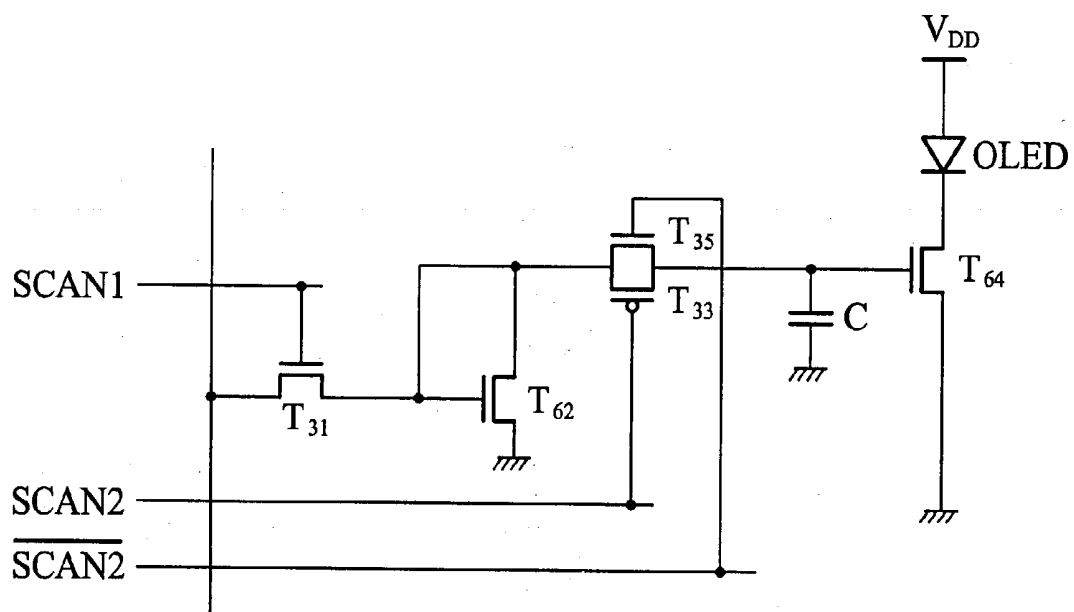


FIG. 9

PIXEL STRUCTURE FOR AN ACTIVE MATRIX OLED

BACKGROUND OF THE INVENTION

[0001] 1. Field of the Invention

[0002] The invention relates to a pixel structure, and more particularly to a current programmed pixel structure for an active matrix organic light emitting diode.

[0003] 2. Description of the Related Art

[0004] Generally, in an active matrix display, images are displayed by numerous pixels in the matrix, and brightness of each pixel is controlled according to brightness data.

[0005] FIG. 1 show a conventional pixel structure 10 for an active matrix organic light emitting diode (AMOLED). The transistor T_1 is turned on when the scan line is activated in the programming state, and the data line sinks or supplies current for the specific driving transistor T_2 . Meanwhile, gate-source voltage of the transistor T_2 is adjusted and stored in the storage capacitor C_1 . In the next state while the scan line is deactivated, often called the reproduction state, the transistor T_1 is turned off and the transistor T_2 is electrically separated from the data line. The gate-source voltage stored in the storage capacitor C_1 may reproduce the current for the OLED, which illuminates accordingly. Threshold voltage of each driving transistor T_2 in the conventional pixel structure, however, deviates due to process variation, and this deviation may result in great variation of the output driving current through OLEDs, such that the brightness of each OLED is discordant and there is lack of uniformity in the OLEDs.

[0006] Therefore, the improved pixel structure 20 shown in FIG. 2 is promoted. Transistors T_3 and T_4 are turned on when the scan lines SCAN1 and SCAN2 are activated in the programming state, and the data line sinks or supplies current through the transistor T_5 , such that the driving current may flow through the OLED and the storage capacitor C_2 is charged or discharged due to the current mirror structure composed of transistors T_5 and T_6 . In the reproduction state, the transistors T_3 and T_4 are turned off when the scan lines SCAN1 and SCAN2 are deactivated, such that the transistor T_6 is electrically separated from the data line, and the gate-source voltage of the transistor T_5 is stored by the storage capacitor C_2 . Based on this structure, the current through transistor T_5 is

$$\frac{I_{OLED}}{I_5} = \frac{(W_6 \times L_5)}{(W_5 \times L_6)},$$

[0007] Therefore

$$I_{OLED} = I_5 \times \frac{(W_6 \times L_5)}{(W_5 \times L_6)}$$

[0008] and then the driving current flowing into the OLED is

$$I_5 = k(V_{gs} - V_t)^2 \times \frac{W_5}{L_5}, \text{ and}$$

$$I_{OLED} = k(V_{gs} - V_t)^2 \times \frac{W_6}{L_6}, \text{ wherein } k = \frac{\mu C_{ox}}{2}$$

[0009] Thus, the driving current flows into the OLED according to sizes of the transistors T_5 and T_6 , and regardless of threshold voltage and process variation of the transistors.

[0010] In the current programming pixel structure 20, the voltage on the drain terminal of the transistor T_5 , however, is increased to VDD when the scan line is deactivated, such that this voltage of the transistor T_5 is coupled to the storage capacitor C_2 by the parasitical capacitor between the gate terminal and drain terminal. Therefore, this deviation may still result in variation of the output driving current through OLEDs.

SUMMARY OF THE INVENTION

[0011] The present invention is directed to a current programmed AMOLED pixel structure capable of providing current to OLEDs stably and precisely, regardless of process variation.

[0012] The present invention is also directed to a current programmed AMOLED pixel structure capable of improving switching effect caused by switching transistors, thereby increasing reliability.

[0013] In the present invention, a first switching transistor has a control terminal coupled to a first scan line, and a first terminal coupled to a data line. A first P-type transistor has a drain terminal and a gate terminal coupled to each other, and a source terminal coupled to a voltage source, and the drain terminal is also coupled to a second terminal of the first switching transistor. A second switching transistor has a first terminal coupled to the gate terminal of the first P-type transistor, and a control terminal coupled to a second scan line. A second P-type transistor has a source terminal coupled to the voltage source, and a gate terminal coupled to a second terminal of the second switching transistor. A storage capacitor is coupled between the voltage source and the gate terminal of the second P-type transistor. An OLED has an anode coupled to the drain terminal of the second P-type transistor and a cathode coupled to ground.

DESCRIPTION OF THE DRAWINGS

[0014] For a better understanding of the present invention, reference is made to a detailed description to be read in conjunction with the accompanying drawings, in which:

[0015] FIG. 1 is a conventional pixel structure for AMOLED;

[0016] FIG. 2 is another conventional pixel structure for AMOLED;

[0017] FIG. 3 shows a pixel structure for AMOLED according to the present invention;

[0018] FIG. 4 shows another pixel structure for AMOLED according to the present invention;

[0019] FIG. 5 shows another pixel structure for AMOLED according to the present invention;

[0020] FIG. 6a shows a display device with AMOLED pixel structures as shown in FIG. 3 according to the present invention;

[0021] FIG. 6b shows another display device with AMOLED pixel structures as shown in FIGS. 4 and 5 according to the present invention;

[0022] FIG. 7 shows another pixel structure for AMOLED according to the present invention;

[0023] FIG. 8 shows another pixel structure for AMOLED according to the present invention;

[0024] FIG. 9 shows another pixel structure for AMOLED according to the present invention.

DETAILED DESCRIPTION OF THE INVENTION

[0025] FIG. 3 shows a pixel structure for AMOLED according to the present invention. As shown in FIG. 3, a switching transistor T_{31} has a first terminal coupled to a data line, and a control terminal coupled to a scan line SCAN1. A transistor T_{32} has a drain terminal coupled to the source terminal thereof, and to a second terminal of the switching transistor T_{31} , and a source terminal coupled to a voltage source VDD. A switching transistor T_{33} has a first terminal coupled to the gate terminal of the transistor T_{32} , and a control terminal coupled to a second scan line SCAN2. A transistor T_{34} has a source terminal coupled to the voltage source VDD, and a gate terminal coupled to a second terminal of the switching transistor T_{33} . A storage capacitor C_3 has two ends coupled between the voltage source VDD and the gate terminal of the transistor T_{34} . An organic light emitting diode OLED has an anode coupled to the drain terminal of the P-type transistor T_{34} and a cathode coupled to ground.

[0026] The switching transistor T_{31} controls the electrical connection between this pixel structure and the data line by the scan line SCAN1, and a current I_w flows through the transistor T_{32} . The switching transistor T_{32} electrically connects the gate terminal of the transistor T_{32} to the gate terminal of the transistor T_{34} during the programming state. Transistor T_{34} outputs corresponding driving current I_{drv} to the organic light emitting diode OLED according to the voltage stored in the storage capacitor C_3 on the gate terminal thereof.

[0027] The gate terminals of the transistors T_{32} and T_{34} are coupled to each other by the switching transistor T_{33} , such that a current mirror is constructed. Thus, the driving current I_{drv} is in proportion to the current I_w .

[0028] FIG. 6a shows a display device with AMOLED pixel structures as shown in FIG. 3 according to the present invention. A scan line driving circuit 21 activates scan lines continuously, and a data line driving circuit 22 with a current source provides current to the data lines according to the brightness data. A plurality of pixel structures 25 are positioned at intersections between two scans lines and one data line, and every pixel structure 25 is the same as structure shown in FIG. 3.

[0029] The driving method of the pixel structure according to the present invention follows. The transistors T_{31} and T_{33} ,

first, are turned on when the scan lines SCAN1 and SCAN2 are in the programming state, such that a current I_w flows through the transistor T_{32} due to the data line with current source, wherein the current source varies according to brightness data.

[0030] The scan line SCAN2 then is deactivated prior to the scan line SCAN1 during the reproduction state, such that transistor T_{33} is turned off to electrically separate the transistor T_{32} from the transistor T_{34} . Next, the scan line SCAN1 is deactivated to electrically separate this pixel structure from the data line. After that, the gate voltage on the transistor T_{34} is stored in the storage capacitor C_3 , and another pixel structure is programmed by the data line.

[0031] Therefore, the driving current I_{drv} is in proportion to the current I_w , regardless of threshold voltage and process variation of the transistors because a current mirror is constructed when the gate terminals of the transistors T_{32} and T_{34} are coupled to each other by the switching transistor T_{33} during the programming state. Though the drain-gate voltage is increased when the transistor T_{31} is turned off, the transistor T_{32} is electrically separated from the storage capacitor C_3 because the transistor T_{33} is turned off prior to the transistor T_{31} , such that the voltage stored in the storage capacitor C_3 is less sensitive to the switching effects, also called feedthrough effect, caused by the transistor T_{31} . In addition, the switching transistors T_{31} and T_{33} and transistors T_{32} and T_{34} are p-type thin film transistors, but can also be replaced by N-type thin film transistors. As shown in FIG. 7, the transistors T_{32} and T_{34} are replaced by N-type thin film transistors T_{62} and T_{64} , and the driving method thereof is the same as the pixel structure as shown in FIG. 3.

[0032] However, when the switching transistor T_{33} switches according to the scan line SCAN2, the transistor T_{33} still results in a feedthrough effect to couple to the storage capacitor C_3 , such that the gate voltage of the transistor T_{34} may still suffer from the feedthrough effect, and the driving current is deviated from the current value programmed during the programming state.

[0033] To address this problem, another embodiment is proposed as follows. FIG. 4 shows another pixel structure for AMOLED according to the present invention. For brevity, the elements in FIG. 4 the same as or similar with the elements in FIG. 3 are depicted by the same numerals or notations. As shown in FIG. 4, the pixel structure further has a capacitive element. In this case, this capacitive element is a dummy transistor T_{41} with source terminal and drain terminal coupled to the second terminal of the transistor T_{32} and the gate terminal of the transistor T_{34} respectively, and a gate terminal coupled to a compensation scan line /SCAN2. The drain terminal and the source of the dummy transistor T_{41} are coupled to each other, and the compensation scan line /SCAN2 is activated when the second scan line SCAN2 is deactivated, and the compensation scan line /SCAN2 is deactivated when the second scan line SCAN2 is activated. The size of the dummy transistor and the switching transistor T_{31} , sometime, is not equal, for example, the dummy transistor T_{41} has half size of the switching transistor T_{33} .

[0034] The feedthrough effect caused by switching transistor T_{33} is compensated for by the dummy transistor T_{41} . For example, the dummy transistor results in a reverse feedthrough effect to compensate for the feedthrough effect

caused by transistor T_{33} because compensation scan line /SCAN2 is activated when the second scan line SCAN2 is deactivated and the compensation scan /SCAN2 line is deactivated when the second scan line SCAN2 is activated, such that the voltage stored in the storage capacitor C_3 are less sensitive to the feedthrough effects caused by transistor T_{33} . In addition, the switching transistors T_{31} and T_{33} and transistors T_{32} and T_{34} are p-type thin film transistors, but can also be replaced by N-type thin film transistors. As shown in FIG. 8, the transistors T_{32} and T_{34} are replaced by N-type thin film transistors T_{62} and T_{64} , and the driving method thereof is the same as the pixel structure as shown in FIG. 4. FIG. 6b shows a display device with AMOLED pixel structures as shown in FIG. 4 according to the present invention. A scan line driving circuit 21 activates scan lines continuously, and a data line driving circuit 22 with a current source provides current to the data lines according to the brightness data. A plurality of pixel structures 25 are positioned at intersections between two scans lines and one data line, and every pixel structure 25 is the same as pixel structure shown in FIG. 4.

[0035] Also, to address the feedthrough effect caused by the transistor T_{33} , another embodiment is proposed as follows. FIG. 5 shows another pixel structure for AMOLED according to the present invention. For brevity, the elements in FIG. 5 the same as or similar with the elements in FIG. 3 are depicted in the same numerals or notations. As shown in FIG. 5, the pixel structure further has a switch transistor T_{35} . This transistor T_{35} has two terminals coupled to the first terminal and the second terminal of the switch transistor T_{33} respectively to construct a CMOS switch device, and a gate terminal coupled to compensation scan line /SCAN2 wherein the compensation scan line /SCAN2 is activated when the second scan line SCAN2 is deactivated, and the compensation scan line /SCAN2 is deactivated when the second scan SCAN2 line is activated.

[0036] The feedthrough effect caused by switching transistor T_{33} is canceled by the switching transistor T_{35} . For example, if the switching transistor T_{35} results in a reverse feedthrough effect to cancel the feedthrough effect caused by transistor T_{33} because transistors T_{35} and T_{33} construct the CMOS switching device and are controlled by scan line SCAN2 and compensation scan line /SCAN2, such that the voltage stored in the storage capacitor C_3 is not sensitive to the feedthrough effects caused by transistor T_{33} . In addition, the switching transistors T_{31} and T_{33} and transistors T_{32} and T_{34} are p-type thin film transistors, but can also be replaced by N-type thin film transistors. As shown in FIG. 9, the transistors T_{32} and T_{34} are replaced by N-type thin film transistors T_{62} and T_{64} , and the driving method thereof is the same as the pixel structure as shown in FIG. 5.

[0037] While the invention has been described by way of example and in terms of the preferred embodiments, it is to be understood that the invention is not limited to the disclosed embodiments. To the contrary, it is intended to cover various modifications and similar arrangements (as would be apparent to those skilled in the art). Thus, the scope of the appended claims should be accorded the broadest interpretation so as to encompass all such modifications and similar arrangements.

What is claimed is:

1. A pixel structure for an active matrix OLED, comprising:

a first switching device having a control terminal coupled to a first scan line and a first terminal coupled to a data line;

a first P-type transistor having a drain terminal and a gate terminal coupled to each other and a source terminal coupled to a voltage source, wherein the drain terminal of the first P-type transistor is coupled to a second terminal of the first switch transistor;

a second switching device having a first terminal coupled to the gate terminal of the first P-type transistor and a control terminal coupled to a second scan line;

a second P-type transistor having a source terminal coupled to the voltage source and a gate terminal coupled to a second terminal of the second switch transistor;

a storage capacitor coupled between the voltage source and the gate terminal of the second P-type transistor; and

an OLED having an anode coupled to a drain terminal of the second P-type transistor, and a cathode coupled to ground.

2. The pixel structure of claim 1, further comprising:

a capacitive device having two terminals coupled between the second terminal of the second switching transistor and the gate terminal of the second P-type transistor, and a third terminal coupled to a compensation scan line, where the compensation scan line is activated when the second scan line is deactivated, and the compensation scan line is deactivated when the second scan line is activated.

3. The pixel structure of claim 2, wherein the capacitive device is a dummy transistor having a source terminal and a drain terminal coupled to a second terminal of the second switching transistor and the gate terminal of the second P-type transistor respectively, and a gate terminal coupled to the compensation scan line, wherein the source terminal and the drain terminal of the dummy transistor are coupled to each other.

4. The pixel structure of claim 3, wherein the dummy transistor is half the size of the second switching device.

5. The pixel structure of claim 1, further comprising:

a third switching transistor having two terminals coupled to the first terminal and the second terminal of the second switching transistor respectively, and a control terminal coupled to a compensation scan line, wherein the second and switching transistors construct a CMOS switching device, and the compensation scan line is activated when the second scan line is deactivated and the compensation scan line is deactivated when the second scan line is activated.

6. The pixel structure of claim 1, wherein the first switching transistor is a N-type thin film transistor.

7. The pixel structure of claim 1, wherein the first switching transistor is a P-type thin film transistor.

8. The pixel structure of claim 1, wherein the second switching transistor is a N-type thin film transistor.

9. The pixel structure of claim 1, wherein the second switching transistor is a P-type thin film transistor.

10. The pixel structure of claim 5, wherein the third switching transistor is a N-type thin film transistor when the second transistor is a P-type thin film transistor.

11. The pixel structure of claim 5, wherein the third switching transistor is a P-type thin film transistor when the second transistor is a N-type thin film transistor.

12. A pixel structure for an active matrix OLED, comprising:

- a first switching device having a control terminal coupled to a first scan line and a first terminal coupled to a data line;

- a first P-type transistor having a drain terminal and a gate terminal coupled to each other and a source terminal coupled to a voltage source, wherein the drain terminal of the first P-type transistor is coupled to a second terminal of the first switch transistor;

- a second switching device having a first terminal coupled to a gate terminal of the first P-type transistor, and a control terminal coupled to a second scan line;

- a second P-type transistor having a source terminal coupled to the voltage source;

- a dummy transistor having a source terminal and a drain terminal coupled to a second terminal of the second switching transistor and the gate terminal of the second P-type transistor respectively, and a gate terminal coupled to a compensation scan line, wherein the source terminal and the drain terminal of the dummy transistor are coupled to each other, the dummy transistor is half the size of the second switching transistor, the compensation scan line is activated when the second scan line is deactivated and the compensation scan line is deactivated when the second scan line is activated;

- a storage capacitor coupled between the voltage source and a gate terminal of the second P-type transistor; and

- an OLED having an anode coupled to a drain terminal of the second P-type transistor, and a cathode coupled to ground.

13. The pixel structure of claim 1, wherein the first switching transistor is a N-type thin film transistor, and the second switching transistor is a P-type thin film transistor.

14. The pixel structure of claim 1, wherein the first switching transistor is a P-type thin film transistor, and the second switching transistor is a N-type thin film transistor.

15. A pixel structure for an active matrix OLED, comprising:

- a first switching device having a control terminal coupled to a first scan line and a first terminal coupled to a data line;

- a first P-type transistor having a drain terminal and a gate terminal coupled to each other and a source terminal coupled to a voltage source, wherein the drain terminal of the first P-type transistor is coupled to a second terminal of the first switch transistor;

- a second switching device having a first terminal coupled to a gate terminal of the first P-type transistor and a control terminal coupled to a second scan line;

- a third switching transistor having two terminals coupled to the first terminal and the second terminal of the second switching transistor respectively, and a control terminal coupled to a compensation scan line, wherein the second and third switching transistors construct a CMOS switching device and the compensation scan line is activated when the second scan line is deactivated and the compensation scan line is deactivated when the second scan line is activated;

- a second P-type transistor having a source terminal coupled to the voltage source and a gate terminal coupled to a second terminal of the second switch transistor;

- a storage capacitor coupled between the voltage source and the gate terminal of the second P-type transistor; and

- an OLED having an anode coupled to a drain terminal of the second P-type transistor, and a cathode coupled to ground.

16. The pixel structure of claim 15, wherein the first switching transistor is a N-type thin film transistor.

17. The pixel structure of claim 15, wherein the first switching transistor is a P-type thin film transistor.

18. The pixel structure of claim 15, wherein the second switching transistor is a N-type thin film transistor and the third switching transistor is a P-type thin film transistor.

19. The pixel structure of claim 15, wherein the second switching transistor is a P-type thin film transistor and the third switching transistor is a N-type thin film transistor.

* * * * *

专利名称(译)	有源矩阵OLED的像素结构		
公开(公告)号	US20040056604A1	公开(公告)日	2004-03-25
申请号	US10/330247	申请日	2002-12-30
[标]申请(专利权)人(译)	SHIH俊仁 陈尚豊 陈建RU		
申请(专利权)人(译)	SHIH俊仁 陈尚李 陈建RU		
当前申请(专利权)人(译)	SHIH俊仁 陈尚李 陈建RU		
[标]发明人	SHIH JUN REN CHEN SHANG LI CHEN CHIEN RU		
发明人	SHIH, JUN-REN CHEN, SHANG-LI CHEN, CHIEN-RU		
IPC分类号	H01L51/50 G09G3/20 G09G3/30 G09G3/32 H01L29/786 G09G3/10		
CPC分类号	G09G3/3241 G09G2320/0223 G09G2320/0219 G09G2300/0842		
优先权	091121426 2002-09-19 TW		
其他公开文献	US6753655		
外部链接	Espacenet USPTO		

摘要(译)

用于有源矩阵OLED的像素结构。第一开关晶体管具有耦合到第一扫描线的控制端子，以及耦合到数据线的第一端子。第一P型晶体管具有彼此耦合的漏极和栅极，以及耦合到电压源的源极。漏极还耦合到第一开关晶体管的第二端子。第二P型晶体管具有耦合到电压源的源极，第二开关晶体管具有耦合在第一和第二P型晶体管的栅极之间的两个端子，以及耦合到第二扫描线的控制端子。存储电容器耦合在电压源和第二P型晶体管的栅极之间。OLED具有耦合到第二P型晶体管的漏极的阳极和耦合到地的阴极。

